

SEMICONDUCTOR PARTICLE DETECTOR BASED ON WORK FUNCTION MODULATION

ELAINE RHOADES, DR. WILLIAM HUNT, AARON GREEN

GEORGIA INSTITUTE OF TECHNOLOGY

MARCH 3, 2020 AT THE APS MARCH MEETING

SESSION G10: DETECTORS, SENSORS, AND

TRANSDUCERS

CREATING THE NEXT®

Funding Statements

This material is based upon work supported by the U.S. Department of Energy, Office of Science, Office of Workforce Development for Teachers and Scientists, Office of Science Graduate Student Research (SCGSR) program. The SCGSR program is administered by the Oak Ridge Institute for Science and Education for the DOE under contract number DE-SC0014664.

Sandia National Laboratories is a multimission laboratory managed and operated by National Technology & Engineering Solutions of Sandia, LLC, a wholly owned subsidiary of Honeywell International Inc., for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-NA0003525.

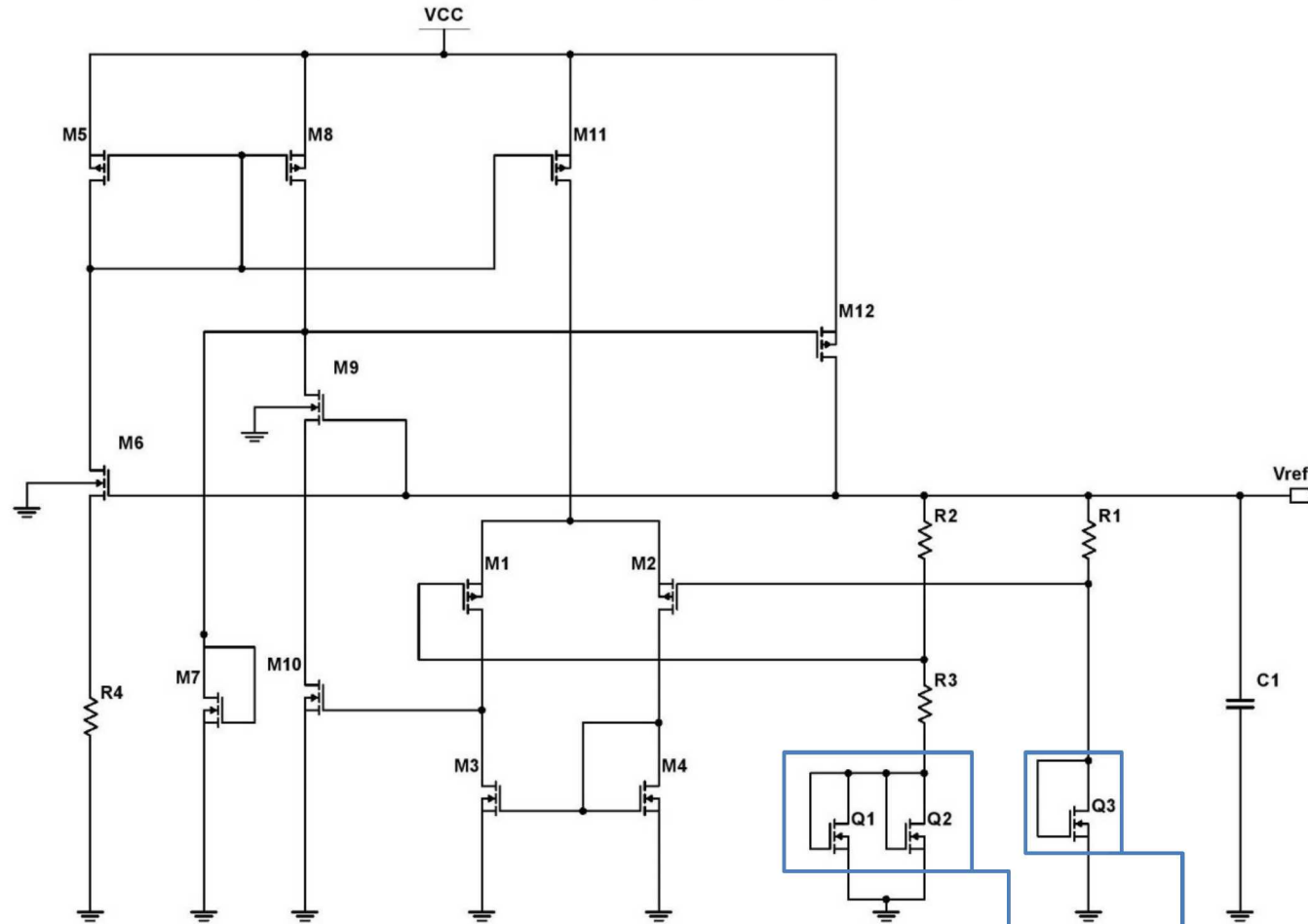
Project Objectives

- Energy transfer to crystal lattice generates primary knock-on atoms which create electron-hole pairs – record current to determine particle energy
 - Standard method of detection for solid-state particle detectors
- Utilize transient signatures in a solid-state detector to generate a new mechanism of particle detection
- Novel approach: record fluctuations in Schottky barrier height of a gallium nitride (GaN) Schottky diode to identify particle events
 - Circuit design: bandgap reference circuit that outputs Schottky barrier height
- Hypothesize that the signature of the fluctuations will be different for different types of particles
 - Focus on neutron detection, with comparison to alpha particles

Bandgap Reference (BGR) Circuit

- Goal of bandgap reference circuit: analog circuit whose voltage output equals that of the bandgap of the semiconductor being used
- Output of typical semiconductor devices is heavily temperature-dependent
- BGR circuit produces a constant output voltage independent of temperature variations, supply variations, and loading
- Bandgap reference adds components to cancel the effects of temperature, both PTAT and CTAT
 - PTAT – proportional to absolute temperature
 - CTAT – complimentary to absolute temperature
- Our bandgap reference circuit design provides an output voltage equal to the Schottky barrier height of a GaN Schottky diode, which is a stable baseline for observing output fluctuations due to particle events
 - Temperature independence important to lend confidence that fluctuations observed are *not* due to temperature variations

Bandgap Reference Circuit

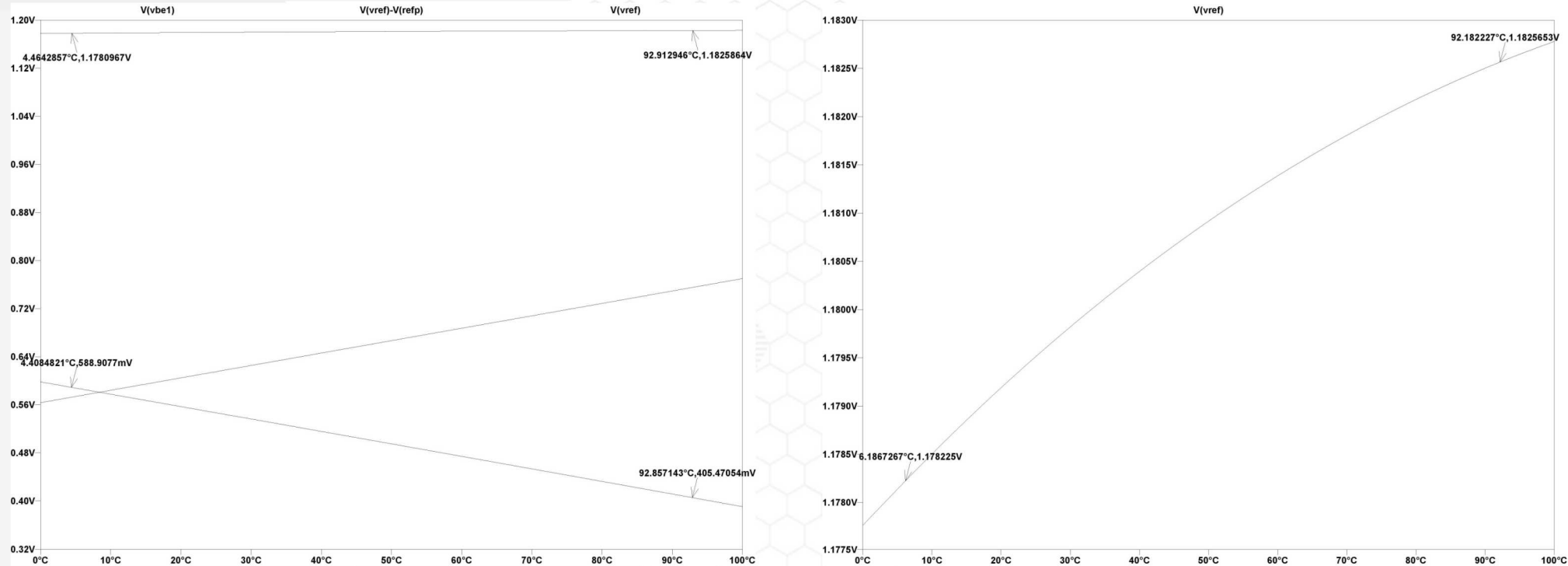


Circuit Modified from Fig 7-22, CMOS bandgap reference with substrate diodes
Camenzind, Hans. Designing Analog Chips. BookSurge, 2005.

Transistor/Schottky diode
exposed to radiation

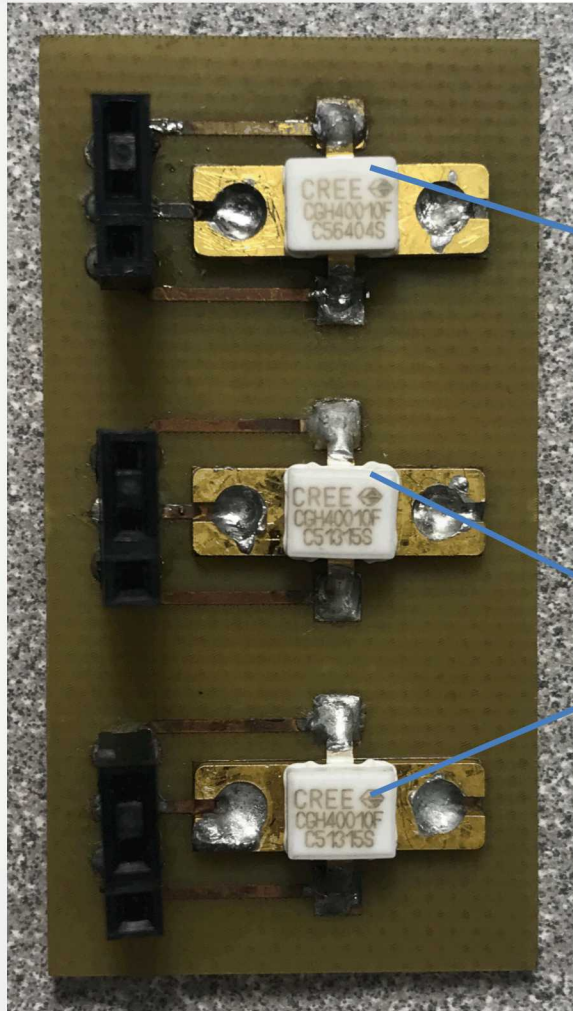
Reference transistors/Schottky
diodes

Temperature Response



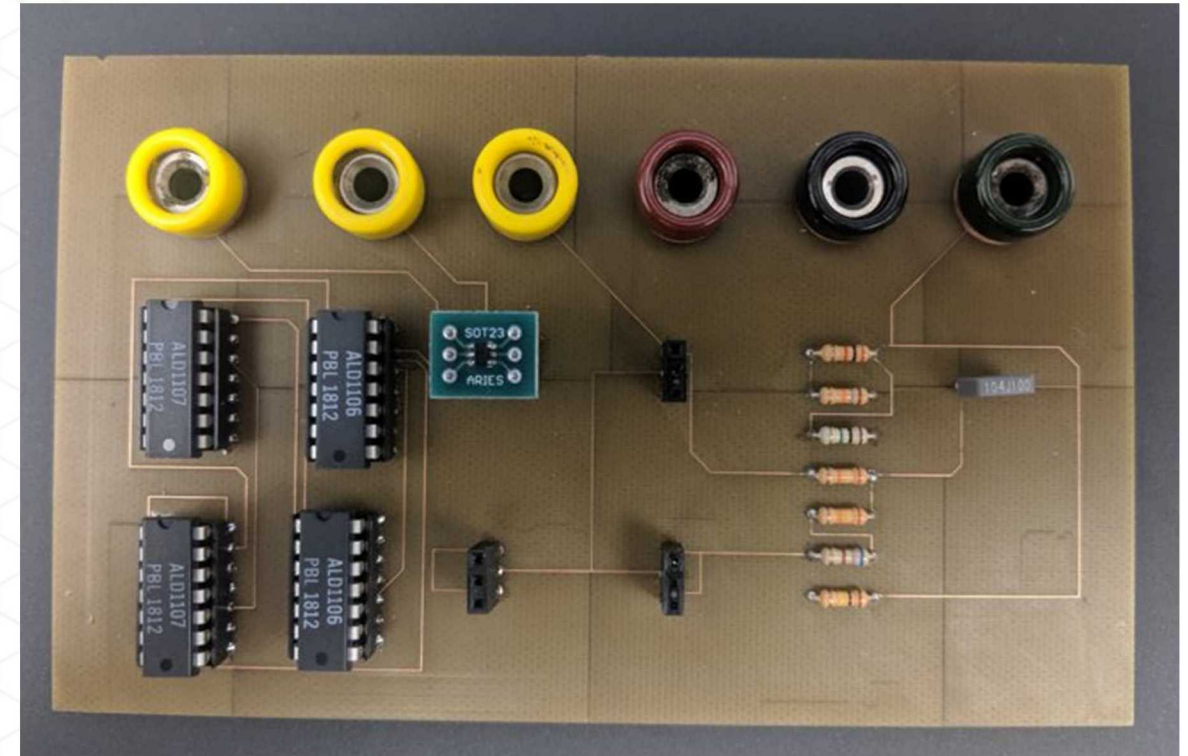
- ▶ Typical temperature dependence of a transistor $-2 \text{ mV}/^{\circ}\text{C}$
 - ▶ Our simulation: slope of V_{gs} is $-2.07 \text{ mV}/^{\circ}\text{C}$
- ▶ Typical slope of reference voltage is variation of 1.8% across 0°C to 100°C
 - ▶ Our simulation: slope of reference voltage is $50.76 \text{ } \mu\text{V}/^{\circ}\text{C}$ (0.365% change)

Bandgap Reference PCB



Transistor/Schottky diode
exposed to radiation
(corresponds to Q3 on
schematic)

Reference
transistors/Schottky
diodes (corresponds to
Q1 and Q2 on schematic)



PCB manufactured at Georgia Tech Interdisciplinary
Design Commons

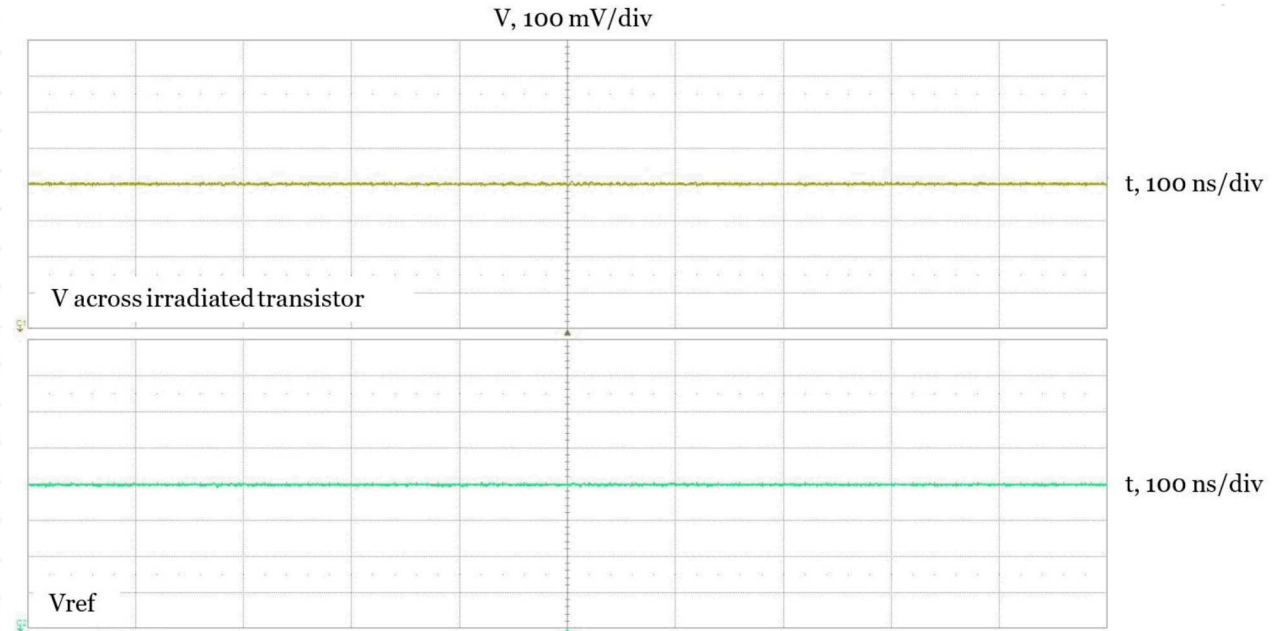
Circuit Irradiation Testing

- Equipment
 - LeCroy Wave Runner 620Zi oscilloscope
 - 2 GHz max bandwidth, 20 Gs/s sample rate
 - Voltage resolution: 100 mV/div
 - Time resolution: 100 ns/div
 - Protek 3003B DC power supply set to +5V
 - PCB circuit board and transistor adapter
- Experimental details
 - Data collection was not continuous
 - Reference transistors were on the same board as the testing transistor – possible confounds in transient measurement, reference transistors may have been irradiated/source of signal
 - Operational amplifier not functioning correctly so was disconnected/not used

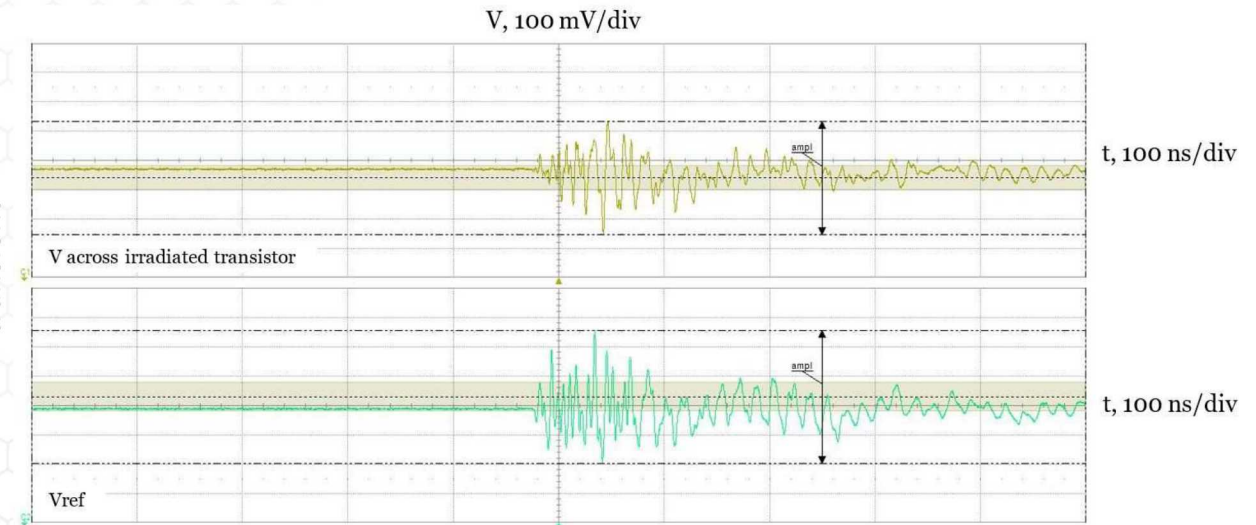
Neutron Source

- Source: AmLi
- Approximately 1 decay per 17.3 ns interacting with the irradiated transistor at 1cm
- Time between potential events means transients could contain up to 12 neutron-device interactions
- Amplitude of transients
 - Average: 250 mV
 - Minimum observed: 100 mV
 - Maximum observed: 400 mV
- Decay time
 - Shortest decay observed: 350 ns
 - Longest decay observed: 500+ ns (limitation of scope)

No source - reference



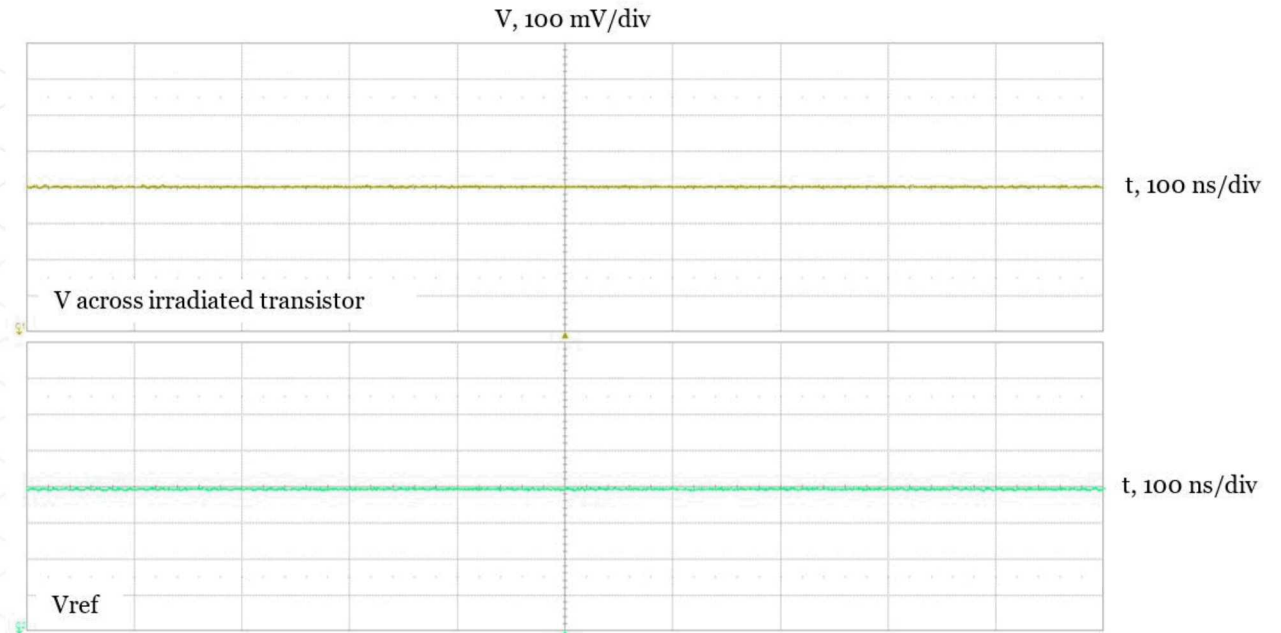
With source - observed transient



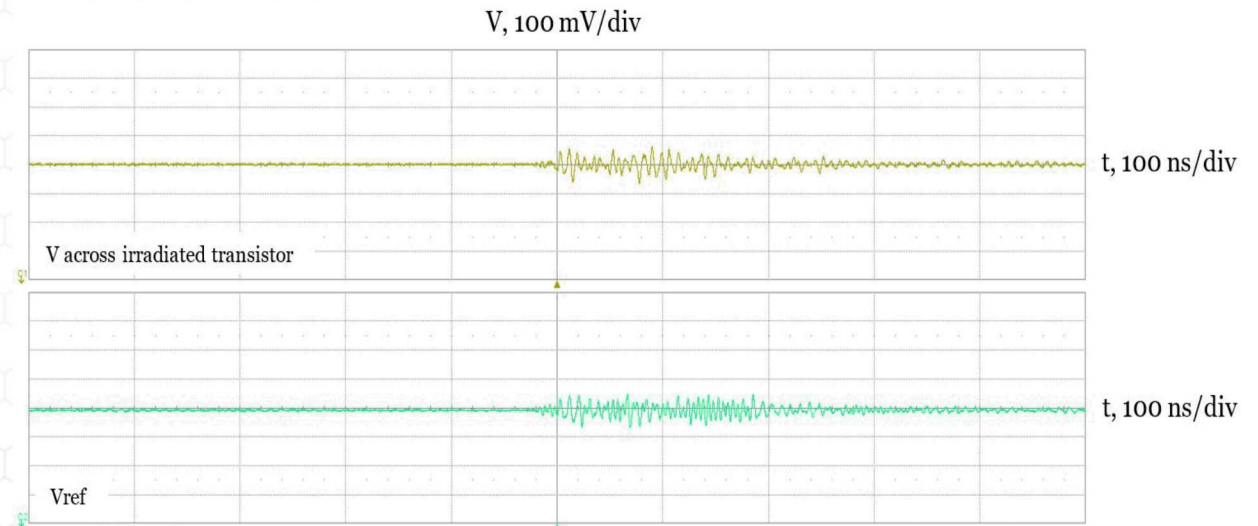
Alpha Source

- Source: Am-241
- Approximately decay per 31.3 ms interacting with the irradiated transistor at 1cm
- Time between potential events leads to confidence of single-particle detection
- Amplitude of transients
 - Average: 150 mV
 - Minimum observed: 100 mV
 - Maximum observed: 400 mV
- Decay time
 - Shortest decay observed: 200 ns
 - Longest decay observed: 500+ ns (limitation of scope)

No source - reference



With source - observed transient



Conclusions

Elaine Rhoades – erhoades3@gatech.edu



- Designed a bandgap reference circuit that uses GaN semiconductor devices as a detector for neutrons
- Performed circuit simulations showing output stability across range of temperatures
- Produced and fabricated a prototype circuit board of the BGR circuit
- Irradiation testing of the fabricated PCB indicates
 - Output is low-noise under non-irradiative conditions
 - Transient signatures are observable
 - Difference in transients observed for neutron and alpha irradiation
- Upcoming work
 - Expand circuit modeling to include transient modeling
 - Additional irradiation experiments
 - Fabricating GaN device in Geant4 software to model the physics interactions occurring

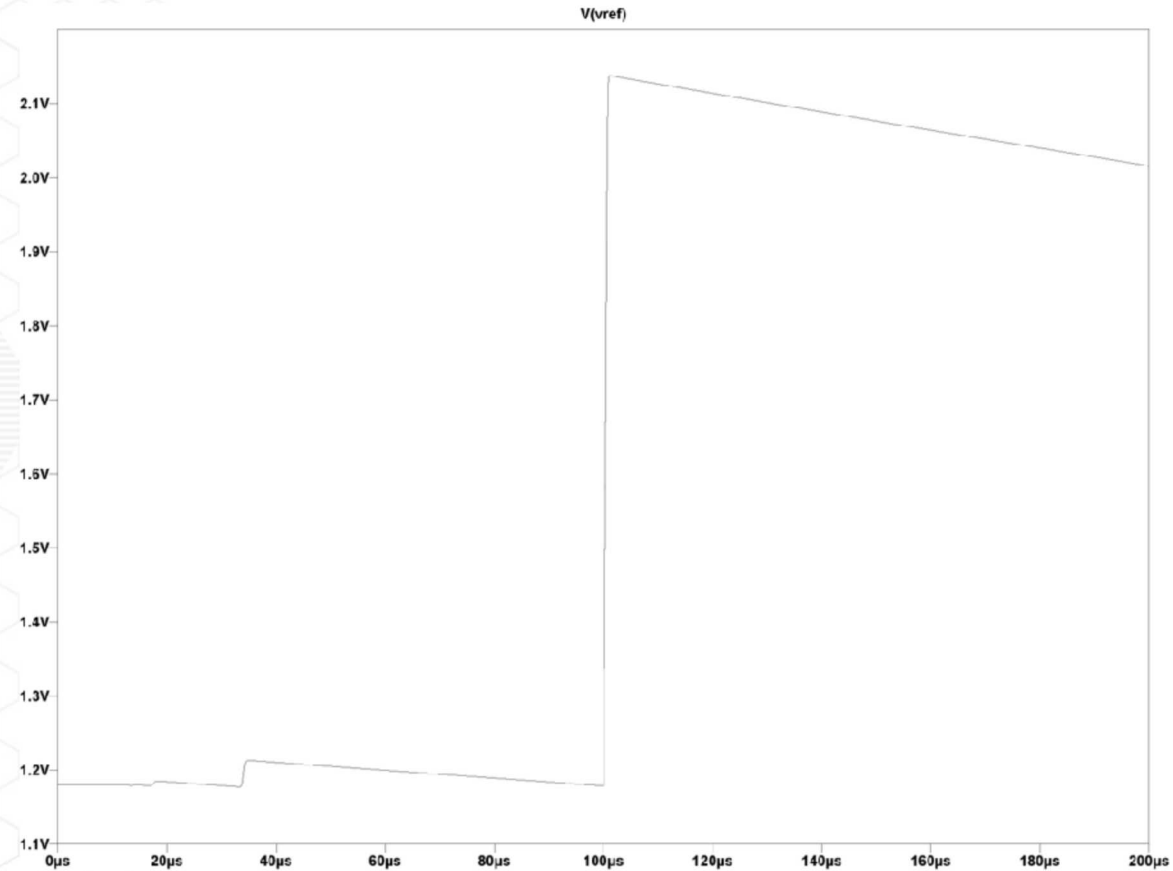
Extra Slides

Significance

- Current detectors are hampered by size and need for multiple stages
- Development of solid state particle detector that can measure energy and momentum would be a significant contribution to particle physics
- Small footprint
 - Application as a portable radiation detector
 - Implementation in current particle detectors for testing and experimental verification
 - Potential to create an array of devices for implementation in larger research experiments
- Potential applications include
 - More accurate dosimeter for protection of radiation workers
 - Utilization in an urban radiation detection network
 - In parallel with other detection techniques like optical radiation detection
 - In conjunction with other detectors for nuclear nonproliferation treaty verification

Transient Response Modeling

- Using data from preliminary testing (August 2018), the event is modeled as a current impulse in the transistor
- Initial simulations seem promising as the impulse is translated to the output voltage V_{ref}
- Simulation result details
 - Modeling was done with generic FET SPICE models before we had Cree models
 - Reference voltage returns to steady state much more slowly than predicted for unknown reason(s)



Transient Response of V_{ref}

Circuit Modeling Upcoming Work

- Recently received complete model for GaN HEMTs from manufacturer Cree
 - Incorporate these models into simulations
- Find and incorporate accurate device models for matched transistors in the circuit
- Continue implementation of transient response modeling
- Investigate why the operational amplifier stage not working in modeling or in experiment